

## Quartz Crystals Product Catalogue

## Network Components Business

## 2001-2002

CMOS IC Quartz Crystals

Micro Batteries Fiber Optics Materials Liquid Crystal Display Custom LCD Module



## Contents

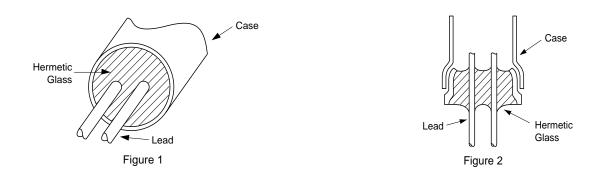
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## **1. Mounting Precautions**

## 1.1 Lead Type Crystal Units

### 1.1.1.Structure

Tubular crystal units (VT, VTC) are hermetically sealed using glass (see Figures 1 and 2).



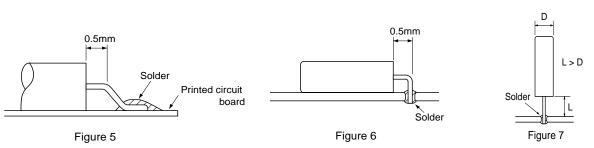
#### 1.1.2 Unbending the lead

- (1) DO NOT pull the lead excessively if unbending a lead or removing a crystal unit. The excessive force may crack the glass and reduce the degree of vacuum. This may eventually result in deterioration of the characteristics and may also break the crystal chip(see Figure 3).
- (2) Unbend the lead by pressing on the bent part from both the upper and lower sides with fixing the bottom of lead tightly. (see Figure 4).



#### 1.1.3 Bending the lead

- (1) Bend the lead so that the lead will remain straight for more than 0.5mm from the case when soldering a crystal unit after bending. If not, the glass may be cracked (see Figures 5 and 6).
- (2) Always leave a length greater than the case diameter when bending a lead after soldering (see Figure 7).



Soldering directly to the case will reduce the degree of vacuum and may result in deterioration of the characteristics and may break the crystal chip.

Make the length from the case to the printed circuit board (L) longer than the case diameter (D) so that the lead wire will not be pulled in case the crystal unit falls over.

#### 1.1.4 Soldering

Heat the lead wire at a temperature of less than 280°C for 5 seconds or less, when mounting or removing a crystal unit. A long period of time of heating may result in deterioration of the characteristics and may break the crystal unit. Be sure to keep the case at or below 150°C.

Quartz Crystal Unit Handling Precautions

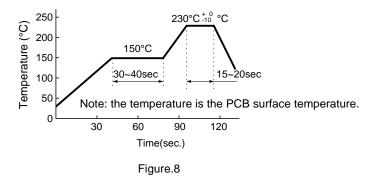
## 1.2 SMD Type Quartz Crystal Units

1.2.1 Soldering

(1) For mounting, it is recommended to solder at less than 230°C for 20 seconds or less. An example of the infrared ray reflow temperature profile is shown as follows (see Figure 8).

#### Example of SMD product soldering conditions

(reflow conditions)



## 2. Cleaning

- (1) Since a small, thin crystal chip is used for low or intermediate frequency crystal units and the frequency approximates that of an ultrasonic cleaner, the crystal chip may break easily. Therefore, DO NOT perform ultrasonic cleaning.
- (2) Other crystal units may also break depending upon the ultrasonic cleaning condition. Please check the ultrasonic cleaning condition.

## 3. Mechanical Shock

- (1) The quartz crystal units are designed to withstand a drop from a height of 75 cm onto a hard wooden board at least three times. However, the crystal chip may break if dropped, depending upon how they are dropped. Ensure that the crystal unit functions normally before use if the crystal units have been dropped or subjected to an excessive mechanical shock.
- (2) Unlike chip parts such as resistors, and capacitors, the SMD crystal unit has a crystal chip which is hermetically sealed inside. Therefore, check the influence of shock caused during automatic mounting before use.

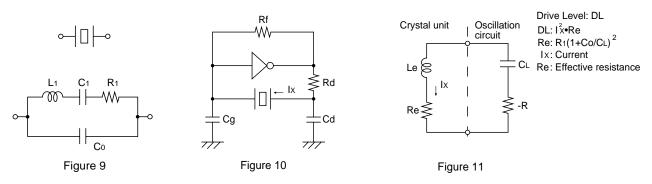


## 1. Drive Level (DL)

The drive level of a crystal unit is shown by the level of the operating power or the current consumption (see Figures 9, 10, and 11).

Operating the crystal unit at an excessive drive level may cause deterioration of characteristics such as the stability of the oscillation frequency or may break the crystal chip.

Depending upon the type of the crystal unit, the appropriate drive level range differs. Ensure that the drive level is appropriate .

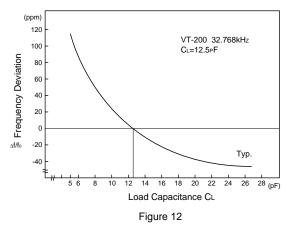


## 2. Oscillation Frequency and Load Capacitance (CL)

The load capacitance ( $C_L$ ) is a parameter for determining the frequency of the oscillation circuit. The  $C_L$  is represented by an effective equivalent capacitance that is loaded from the oscillation circuit to both ends of the crystal unit (see Figures 10 and 11).

The oscillation frequency varies depending upon the load capacitance of the oscillation circuit. In order to obtain the desirable frequency accuracy, matching between the load capacitances of the oscillation circuit and the crystal unit is required. When set to a small load capacitance, the frequency may be influenced by tolerance in the circuit elements. For more details, please contact SII.

Figure 12 shows an example of the frequency vs. load capacitance of a 32.768 kHz VT-200.



## 3. Oscillation Allowance

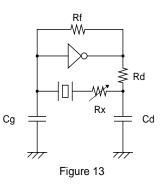
To ensure stable oscillation, the negative resistance of the circuit should be significantly larger than the equivalent series resistance (the oscillation allowance is large). The targeted oscillation allowance is at least five times as large as the equivalent series resistance.

#### **Oscillation Allowance Evaluation Method**

Add resistor "Rx" to the crystal unit in series and ensure that the oscillation starts or stops. The approximate negative resistance of the circuit is the value obtained by adding the effective resistance "Re" to the maximum resistance "Rx" when the oscillation starts or stops after gradually making "Rx" larger.

#### Negative resistance |-R| = Rx + Re

|-R| is a value at least five times as large as the maximum equivalent series resistance (R1 max.) of the crystal unit. \*Re is the effective resistance value during oscillation. Re = R1•(1+ $\frac{C_0}{C_L}$ )<sup>2</sup>





The following is the standard packing.

## 1. Lead type products

| Product name | Quantity per lot | Quantity per bag | Quantity per box |
|--------------|------------------|------------------|------------------|
| VT Series    | 10,000 pcs.      | 500 pcs.         | 20 bags          |
| VTC Series   | 10,000 pcs.      | 500 pcs.         | 20 bags          |

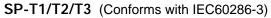
## 2. SMD products

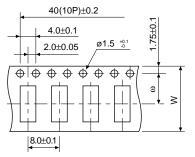
After being taped, the products are rolled onto a reel. The reels are packed in a box.

| SP Series         | SP-T1      | SP-T2      | SP-T3      | HTF-VT/VTC | SSP-T5     | SSP-T6     | SSP-T7     |
|-------------------|------------|------------|------------|------------|------------|------------|------------|
| Quantity per reel | 2,000 pcs. | 3,000 pcs. | 3,000 pcs. | 3,000 pcs. | 6,000 pcs. | 9,000 pcs. | 3,000 pcs. |

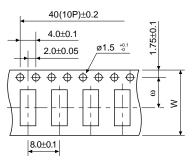
### Tape and reel configuration

•Emboss taping configuration

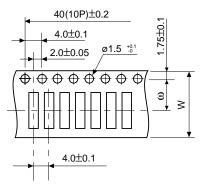




#### HTF-VT/VTC (Conforms with IEC60286-3)



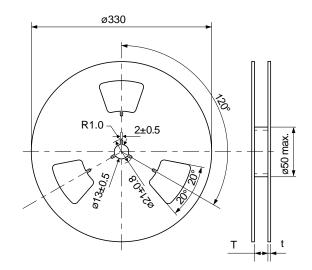
SSP-T5/T6 (Conforms with IEC60286-3)



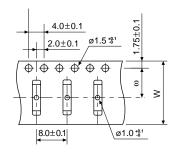
|   | SSP-T5/T6/T7, SP-T1/T2/T3, HTF-VT/VTC |
|---|---------------------------------------|
| ω | 7.5                                   |
| W | 16.0                                  |

#### •Reel configuration

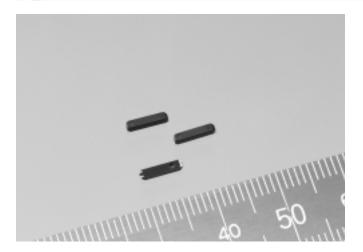
(Conforms with IEC60286-3)



SSP-T7 (Conforms with IEC60286-3)



|   | SSP-T5/T6/T7, SP-T1/T2/T3, HTF-VT /VTC |
|---|--|
| Т | 16.4                                   |
| t | 2.0                                    |



#### FEATURES

- Ultra thin type with height 1.4mm Max.
- SMD type suitable for automatic & high density surface mounting.
- Plastic mold package containing highly reliable tubular type quartz crystal.
- Excellent shock and heat resistance.

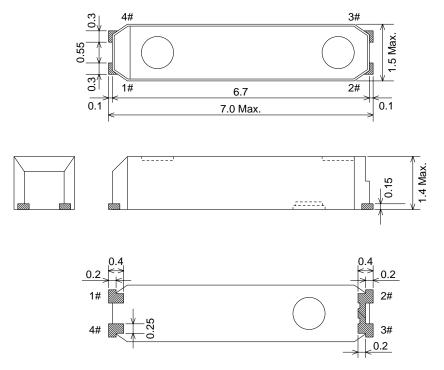
#### **APPLICATIONS**

• Cellular Phones, PDA, Radio Communication Equipment, Portable Applications etc.

#### Conditions without notice (Temperature: +25°C±2°C)

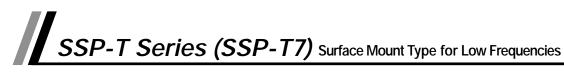
| Item                         | Symbol     | Specifications                                  | Conditions / Notes    |
|------------------------------|------------|---|-----------------------|
| Nominal Frequency            | fo         | 32.768kHz                                       |                       |
| Frequency Tolerance          | ∆ f/fo     | ±20ppm, ±50ppm                                  |                       |
| Turnover Temperature         | Тр         | +25°C±5°C                                       |                       |
| Temperature Coefficient      | К          | (-3.5±1.0) x 1.0 <sup>-8</sup> /°C <sup>2</sup> |                       |
| Load Capacitance             | CL         | 7.0 pF / 12.5pF                                 |                       |
| Equivalent Series Resistance | <b>R</b> 1 | 65kΩ max.                                       |                       |
| Maximum Drive Level          | DLmax      | 1µW   |                       |
| Drive Level                  | DL         | 0.1µW   |                       |
| Shunt Capacitance            | Co         | 0.8pF typ.                                      |                       |
| Aging                        | ∆ f/fo     | ±3ppm max.                                      | +25°C±3°C, First Year |
| Operating Temperature Range  | Торе       | -40°C ~ +85°C                                   |                       |
| Storage Temperature Range    | Tsto       | -55°C ~ +125°C                                  |                       |
| Reflow Profile               | Tsol       | 260°C max. x 5 sec. max.                        | IR Reflow             |

#### DIMENSIONS (For details, please refer to individual specification)

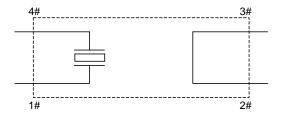


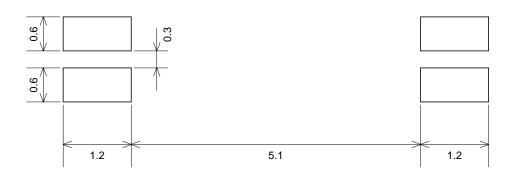
\* Do not connect #2 and #3 to external device.

## STANDARD SPECIFICATIONS

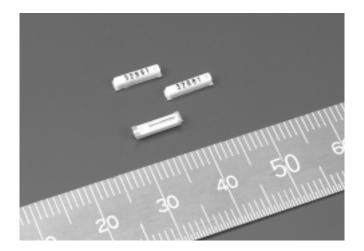


## INTERNAL LEAD CONNECTION





## SSP-T Series (SSP-T6) Surface Mount Quartz Crystal Units for Low Frequencies



#### **FEATURES**

- Ultra thin type with height 1.6mm Max.
- Ultra small mounting area of 16.8mm<sup>2</sup>
- SMD type suitable for automatic & high density surface mounting.
- · Plastic mold package containing highly reliable tubular type quartz crystal.
- Excellent shock and heat resistance.

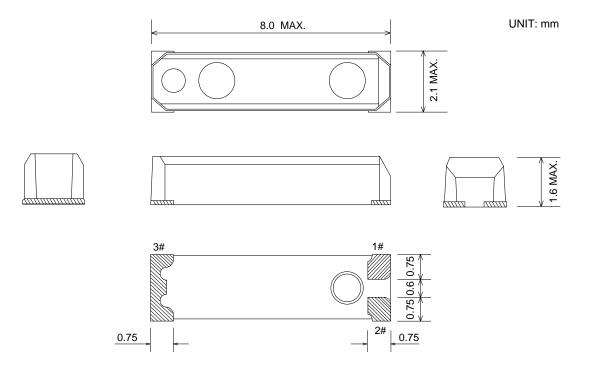
#### **APPLICATIONS**

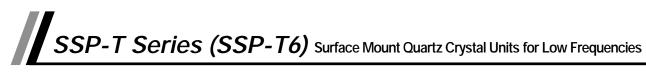
• Cellular Phones, Pagers, Radio Communication Equipment, Portable Applications etc.

| STANDARD SPECIFICAT          | IONS   | Conditions without                             | Conditions without notice (Temperature: +25°C±2°C) |  |  |
|------------------------------|--------|--|--|--|--|
| Item                         | Symbol | Specifications                                 | Conditions / Notes                                 |  |  |
| Nominal Frequency            | fo     | 32.768kHz/75.000kHz                            |  |  |  |
| Frequency Tolerance          | ∆ f/fo | ±10ppm, ±20ppm, ±50ppm                         | Can be used in high accurate products              |  |  |
| Turnover Temperature         | Тр     | +25°C±5°C                                      |  |  |  |
| Temperature Coefficient      | К      | (-3.5±1.0) x 10 <sup>-8</sup> /°C <sup>2</sup> |  |  |  |
| Load Capacitance             | CL     | 7.0pF/12.5pF                                   |  |  |  |
| Equivalent Series Resistance | R1     | 55kΩ max.                                      |  |  |  |
| Maximum Drive Level          | DLmax  | 1μW  |  |  |  |
| Drive Level                  | DL     | 0.1µW  |  |  |  |
| Shunt Capacitance            | Co     | 0.95pF typ.                                    |  |  |  |
| Aging                        | ∆ f/fo | ±3ppm max.                                     | +25°C±3°C, First Year                              |  |  |
| Operating Temperature Range  | Торе   | -40°C ~ +85°C                                  |  |  |  |
| Storage Temperature Range    | Tsto   | -55°C ~ +125°C                                 |  |  |  |
| Reflow Profile               | Tsol   | 230°C max. 20sec. x 2 times                    | IR Reflow  |  |  |

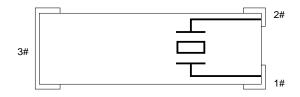
#### STANDARD SPECIFICATIONS

#### DIMENSIONS (For details, please refer to individual specification)

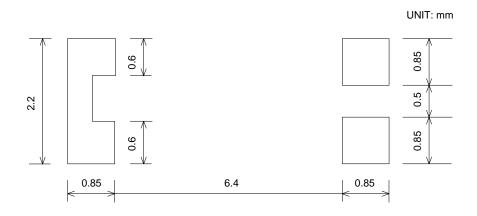




## INTERNAL LEAD CONNECTION

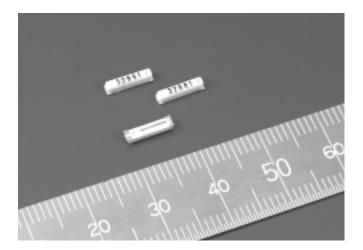


#### **RECOMMENDED SOLDERING PATTERN**



Note: Please make sure that there is no electric wire line under SSP-T6 on the circuit board.

# SSP-T Series (SSP-T5) Surface Mount Quartz Crystal Units for Low Frequencies



#### **FEATURES**

- This type with height 2.1mm Max.
- Small mounting area of 23.4mm<sup>2</sup>.
- SMD type suitable for automatic & high density surface mounting.
- · Plastic mold package containing highly reliable tubular type quartz crystal.
- Excellent shock and heat resistance.

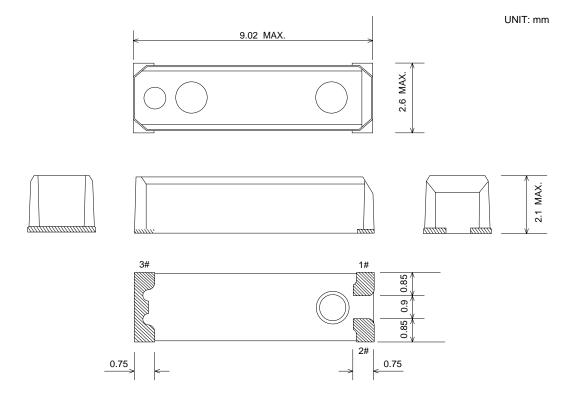
#### **APPLICATIONS**

• Cellular Phones, Pagers, Radio Communication Equipment, Portable Applications etc.

| STANDARD SPECIFICAT          | IONS   | Conditions without r                           | notice (Temperature: +25°C±2°C)       |
|------------------------------|--------|--|---------------------------------------|
| Item                         | Symbol | Specifications                                 | Conditions / Notes                    |
| Nominal Frequency            | fo     | 32.768kHz/76.800kHz                            |                                       |
| Frequency Tolerance          | ∆ f/fo | $\pm$ 10ppm, $\pm$ 20ppm, $\pm$ 50ppm          | Can be used in high accurate products |
| Turnover Temperature         | Тр     | +25°C±5°C                                      |                                       |
| Temperature Coefficient      | к      | (-3.5±0.8) x 10 <sup>-8</sup> /°C <sup>2</sup> |                                       |
| Load Capacitance             | CL     | 6.0pF/12.5pF                                   |                                       |
| Equivalent Series Resistance | R1     | 50kΩ max.                                      |                                       |
| Maximum Drive Level          | DLmax  | 1μW  |                                       |
| Drive Level                  | DL     | 0.1µW  |                                       |
| Shunt Capacitance            | Co     | 0.9pF typ.                                     |                                       |
| Aging                        | ∆ f/fo | ±3ppm max.                                     | +25°C±3°C, First Year                 |
| Operating Temperature Range  | Торе   | -40°C ~ +85°C                                  |                                       |
| Storage Temperature Range    | Tsto   | -55°C ~ +125°C                                 |                                       |
| Reflow Profile               | Tsol   | 230°C max. 20sec. x 2 times                    | IR Reflow                             |

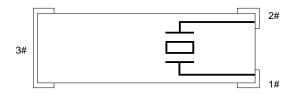
#### STANDARD SPECIFICATIONS

#### DIMENSIONS (For details, please refer to individual specification)

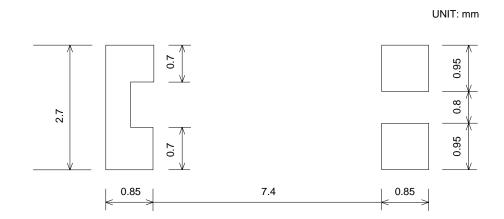




### INTERNAL LEAD CONNECTION



#### **RECOMMENDED SOLDERING PATTERN**



Note: Please make sure that there is no electric wire line under SSP-T5 on the circuit board.

SP-T Series (SP-T3)

### Surface Mount Quartz Crystal Units for Low Frequencies



#### **FEATURES**

- Low height 2.0mm max.
- Plastic mold package incorporated tubular type quartz crystal.
- Suitable for automatic and high density surface mounting.
- Excellent shock and heat resistance.

#### **APPLICATIONS**

• Radio Communication Equipment, Pagers, Cellular Phones, Portable Applications, Clock Source for Micro-Computers

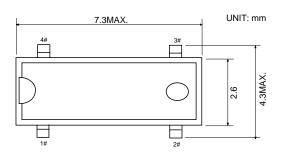
#### STANDARD SPECIFICATIONS

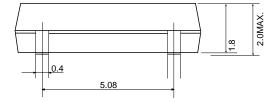
|  | Conditions without notice ( | Temperature: +25°C±2°C) |
|--|-----------------------------|-------------------------|
|--|-----------------------------|-------------------------|

| ltem                         | Symbol | Specifications                                 | Conditions / Notes                    |
|------------------------------|--------|--|---------------------------------------|
| Nominal Frequency            | fo     | 32.768kHz                                      |                                       |
| Frequency Tolerance          | ∆ f/fo | ±20ppm, ±30ppm, ±50ppm,±100ppm                 | Can be used in high accurate products |
| Turnover Temperature         | Тр     | +25°C±5°C                                      |                                       |
| Temperature Coefficient      | К      | (-3.5±1.0) x 10 <sup>-8</sup> /°C <sup>2</sup> |                                       |
| Load Capacitance             | CL     | 6.0 to 12.5pF                                  |                                       |
| Equivalent Series Resistance | R1     | 55kΩ max.                                      |                                       |
| Maximum Drive Level          | DLmax  | 1μW  |                                       |
| Drive Level                  | DL     | 0.1µW  |                                       |
| Shunt Capacitance            | Co     | 0.9pF typ.                                     |                                       |
| Aging                        | ∆ f/fo | ±3ppm max.                                     | +25°C±3°C, First Year                 |
| Operating Temperature Range  | Торе   | -40°C ~ +85°C                                  |                                       |
| Storage Temperature Range    | Tsto   | -55°C ~ +125°C                                 |                                       |
| Reflow Profile               | Tsol   | 230°C max., 20sec. max. x 2 times              | IR Reflow                             |

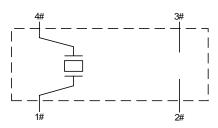
#### DIMENSIONS

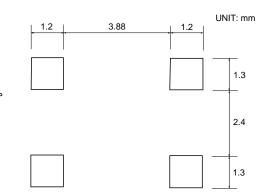
(For details, please refer to individual specification)



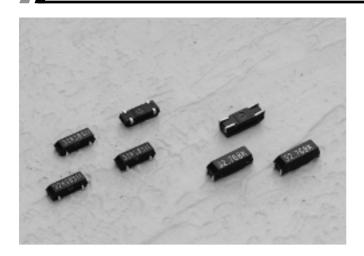


#### INTERNAL LEAD CONNECTION





## SP-T Series (SP-T1/SP-T2) Surface Mount Quartz Crystal Units for Low Frequencies



#### FEATURES

- Plastic mold package incorporated tubular type quartz crystal.
- •Suitable for automatic and high density surface mounting.
- •Excellent shock and heat resistance.

#### **APPLICATIONS**

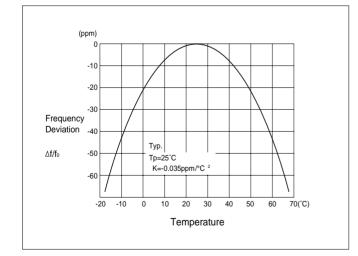
• Radio Communication Equipment, Pagers, Cellular Phones, Camcorders, Portable Applications, Clock Source for Micro-Computers

#### STANDARD SPECIFICATIONS

#### Conditions without notice (Temperature: +25°C±2°C)

| Item                         | Symbol | Specifi          | cations                             | Conditions / Notes    |
|------------------------------|--------|------------------|-------------------------------------|-----------------------|
| Nominal Frequency            | fo     |                  | 32kHz ~ 200kHz                      |                       |
| Frequency Tolerance          | ∆ f/fo | ±20ppm, ±50p     | pm, ±100ppm                         |                       |
| Turnover Temperature         | Тр     | +25°C±5°C        | +25°C±8°C                           |                       |
| Temperature Coefficient      | к      | (-3.5±0.8)       | x 10 <sup>-8</sup> /°C <sup>2</sup> |                       |
| Load Capacitance             | CL     | 6.0 ~ 12.5pF     |                                     |                       |
| Equivalent Series Resistance | R1     | 50kΩ max.        |                                     |                       |
| Maximum Drive Level          | DLmax  | 1μW              |                                     |                       |
| Drive Level                  | DL     | 0.1µW            |                                     |                       |
| Shunt Capacitance            | Co     | 1.0pF typ.       | 0.95pF typ.                         |                       |
| Aging                        | f/fo   | ±5ppm max.       |                                     | +25°C±3°C, First Year |
| Operating Temperature Range  | Торе   | -40°C ~ +85°C    |                                     |                       |
| Storage Temperature Range    | Tsto   | -55°C ~ +125°C   |                                     |                       |
| Reflow Profile               | Tsol   | 230°C max., 20se | ec. max. x 2 times                  | IR Reflow             |

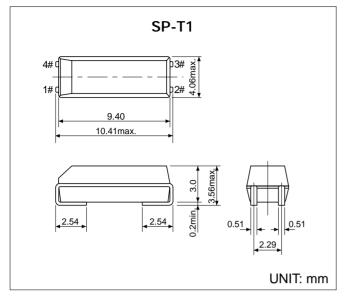
#### FREQUENCY-TEMPERATURE CURVE

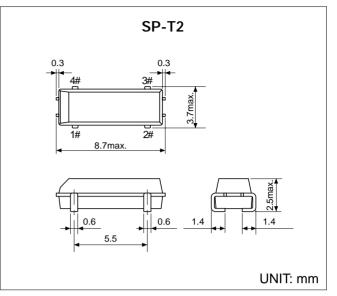


#### STANDARD FREQUENCIES (kHz)

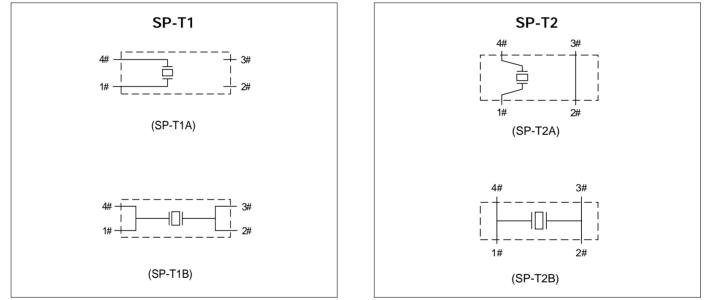
|        | SP-T1/SP-T2 |         |
|--------|-------------|---------|
| 32.000 | 76.800      | 150.000 |
| 32.768 | 96.000      | 153.600 |
| 38.400 | 100.000     | 200.000 |
| 40.000 | 106.000     |         |
| 75.000 | 130.000     |         |

### DIMENSIONS (For details, please refer to individual specification)

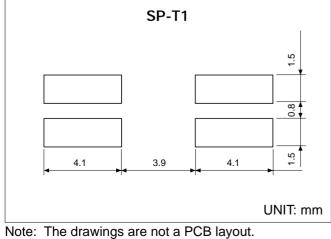




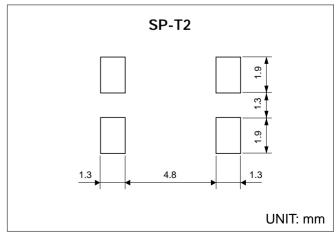
### **INTERNAL LEAD CONNECTION**



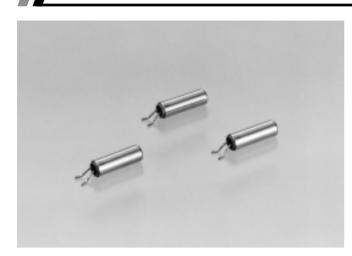
Note: Do not connect terminals #2, #3 of T1A and T2A to the outside electrode. These are dummy terminals.







HTF-VT/VTC Series Surface Mount Quartz Crystal Units for Low Frequencies



#### **FEATURES**

- IR reflowable tubular type crystal with lead bent in tape/ reel.
- Suitable for automatic and high, density surface mounting.
- Excellent shock and heat resistance.

#### **APPLICATIONS**

 Radio Communication Equipment, Pagers, Cellular Phones, Camcorders, Portable Applications, Clock Source for Micro-Computers

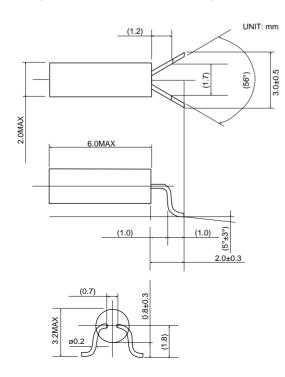
#### STANDARD SPECIFICATIONS

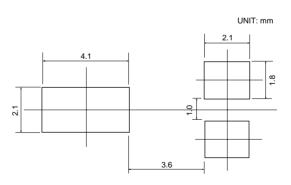
Conditions without notice (Temperature: +25°C±2°C)

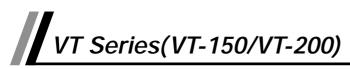
| Item                         | Symbol | Specifications                                 |                    | Conditions / Notes    |
|------------------------------|--------|--|--------------------|-----------------------|
| Nominal Frequency            | fo     | 32.768kHz                                      | 32.0kHz ~ 153.6kHz |                       |
| Frequency Tolerance          | f/fo   | ±30ppm, ±50ppm, ±100ppm                        |                    |                       |
| Turnover Temperature         | Тр     | +25°C±5°C                                      | +25°C±8°C          |                       |
| Temperature Coefficient      | К      | (-3.5±0.8) x 10 <sup>-8</sup> /°C <sup>2</sup> |                    |                       |
| Load Capacitance             | CL     | 6.0 ~ 12.5pF                                   |                    |                       |
| Equivalent Series Resistance | R1     | 50kΩ max.                                      |                    |                       |
| Maximum Drive Level          | DLmax  | 1.0μW  |                    |                       |
| Drive Level                  | DL     | 0.1µW  |                    |                       |
| Shunt Capacitance            | Co     | 0.8pF typ.                                     | 0.5 ~ 0.9pF typ.   |                       |
| Aging                        | f/fo   | ±3ppm max.                                     | ±5ppm max.         | +25°C±3°C, First Year |
| Operating Temperature Range  | Торе   | -40°C ~ +85°C                                  |                    |                       |
| Storage Temperature Range    | Tsto   | -55°C ~ +125°C                                 |                    |                       |
| Reflow Profile               | Tsol   | 230ºC max., 20 sec. max. x 2times              |                    | IR Reflow             |

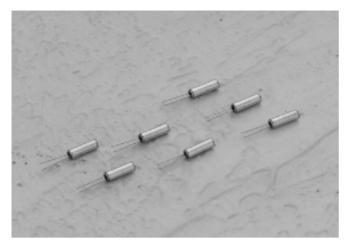
#### DIMENSIONS

(For details, please refer to individual specifications)









#### FEATURES

- Compact tubular package.
- Photolithographic process.
- Excellent shock resistance and environmental characteristics.

#### **APPLICATIONS**

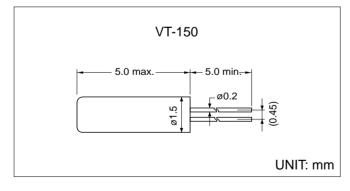
• Real Time Clocks, Timers, Pagers, Cameras, Remote-Controllers, Portable Applications

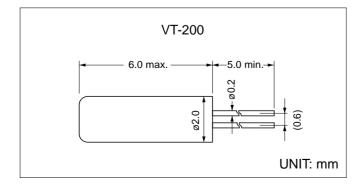
#### STANDARD SPECIFICATIONS

| Conditions without notice ( | Temperature: +25°C±2°C) |
|-----------------------------|-------------------------|
|-----------------------------|-------------------------|

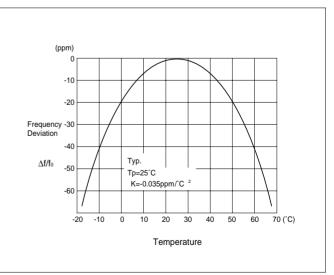
| Item                         | Symbol | Specifications                                 | Conditions / Notes    |
|------------------------------|--------|--|-----------------------|
| Nominal Frequency            | fo     | 32.768kHz                                      |                       |
| Frequency Tolerance          | ∆ f/fo | (±5ppm) ±10ppm, ±20ppm                         |                       |
| Turnover Temperature         | Тр     | +25°C±5°C                                      |                       |
| Temperature Coefficient      | К      | (-3.5±0.8) x 10 <sup>-8</sup> /°C <sup>2</sup> |                       |
| Load Capacitance             | CL     | 4.5 ~12.5pF                                    |                       |
| Equivalent Series Resistance | R1     | 50kΩ max.                                      |                       |
| Maximum Drive Level          | DLmax  | 1μW  |                       |
| Drive Level                  | DL     | 0.1µW  |                       |
| Shunt Capacitance            | Co     | 0.86pF typ.                                    |                       |
| Aging                        | △ f/fo | ±5ppm max.                                     | +25°C±3°C, First Year |
| Operating Temperature Range  | Торе   | -10°C ~ +60°C                                  |                       |
| Storage Temperature Range    | Tsto   | -30°C ~ +70°C                                  |                       |
| Solderability                | Tsol   | 280°C max. 5sec. max (Package 150°C max.)      | Leads Only            |

#### DIMENSIONS





#### FREQUENCY-TEMPERATURE CURVE







### **Quartz Crystal Units for Low Frequencies**

#### **FEATURES**

- •Compact tubular package.
- •Low frequency coverage from 32kHz to 200kHz.
- •Photolithographic process.
- •Excellent shock resistance and environmental characteristics.

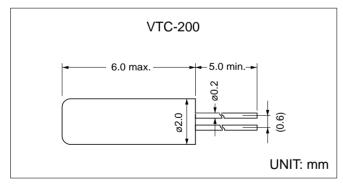
#### **APPLICATIONS**

• Radio Communication Equipment, Clock Source for Micro-Computers, Pagers, Portable Applications

| STANDARD SPECIFICAT          | IONS   |  | Co               | nditions w            | ithout notice (Temp | erature: +25°C±2°C) |
|------------------------------|--------|--|------------------|-----------------------|---------------------|---------------------|
| Item                         | Symbol | Specifications                               |                  |                       | Conditions / Notes  |                     |
| Nominal Frequency            | fo     | 32kHz ~ 49.9kHz                              | 50kHz ~ 79.9kHz  |                       | 80kHz ~ 200kHz      |                     |
| Frequency Tolerance          | ∆ f/fo | ±30ppm, ±50ppm                               |                  |                       |                     |                     |
| Turnover Temperature         | Тр     | +25°C±8°C                                    |                  |                       |                     |                     |
| Temperature Coefficient      | К      | (-3.5±0.8)x10 <sup>-8</sup> /°C <sup>2</sup> |                  |                       |                     |                     |
| Load Capacitance             | CL     | 6.0~12.5pF                                   |                  |                       |                     |                     |
| Equivalent Series Resistance | R1     | 50k $\Omega$ max.                            | $35k\Omega$ max. |                       | 25kΩ max.           |                     |
| Maximum Drive Level          | DLmax  | 1μW  |                  |                       |                     |                     |
| Drive Level                  | DL     | 0.1µW  |                  |                       |                     |                     |
| Shunt Capacitance            | Co     | 0.8pF typ.                                   |                  |                       | 0.75pF typ.         |                     |
| Aging                        | ∆ f/fo | ±5ppm max.                                   |                  | +25°C±3°C, First Year |                     |                     |
| Operating Temperature Range  | Торе   | -10°C ~ +60°C                                |                  |                       |                     |                     |
| Storage Temperature Range    | Tsto   | -30°C ~ +70°C                                |                  |                       |                     |                     |
| Solderability                | Tsol   | 280°C max., 5sec. max (Package 150°C max.)   |                  |                       | Leads Only          |                     |

#### STANDARD SPECIFICATIONS

#### DIMENSIONS



#### **STANDARD FREQUENCIES**

|        | VTC-200 |         |
|--------|---------|---------|
| 32.000 | 96.000  | 153.600 |
| 38.400 | 100.000 | 200.000 |
| 40.000 | 106.000 |         |
| 75.000 | 130.000 |         |
| 76.800 | 150.000 |         |

Note: For more information regarding available frequencies, please contact with us.

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#### Seiko Instruments Inc.

Network Components Business 1-8, Nakase, Mihama-ku, Chiba-shi, Chiba 261-8507, Japan Telephone :+81-43-211-1207 Facsimile :+81-43-211-8032 E-mail:component@sii.co.jp

Seiko Instruments USA Inc. Electronic Components Div. 2990 W. Lomita Blvd., Torrance, CA 90505, U.S.A. Telephone :+1-800-934-9334 Facsimile :+1-909-975-5699 E-mail :seiko-ecd@salessupport.com

#### http://www.seiko-usa-ecd.com Seiko Instruments GmbH

Semensstrasse 9, D-63263 Neu-Isenburg, Germany Telephone :+49-6102-297-0 Facsimile :+49-6102-297-320 E-mail :info@seiko-instruments.de http://www.seiko-instruments.de/

#### Seiko Instruments France S.A.R.L.

55, Rue d' Aguesseau, 92774, Boulogne Billancourt, Cedex, France Telephone :+33-1-4131-7130 Facsimile :+33-1-4131-7139 E-mail :info@seiko-instruments.fr http://www.seiko-instruments.fr

Seiko Instruments (H.K.) Ltd. 4-5 / F, Wyler Centre 2,200 Tai Lin Pai Road, Kwai Chung, N.T., Kowloon, Hong Kong Telephone :+852-2421-8611 Facsimile :+852-2480-5479 E-mail :sales@sih.com.hk http://www.sih.com.hk/sih/index.html

#### Seiko Instruments Taiwan Inc.

4FL, No.40, Sec. 2, Min Chuan E. Rd., Taipei 104, Taiwan, R.O.C. Telephone :+886-2-2563-5001 Facsimile :+886-2-2521-9519 E-mail :public@sii.co.jp http://www.sii.com.tw/

Seiko Instruments Singapore Pte. Ltd. 2, Marsiling Lane, Woodlands New Town, Singapore 739144 Telephone :+65-269-1370 Facsimile :+65-269-9729 http://www.sii.com.sg/home.htm

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